EPO-TEK® 320NC-2

Epoxy; Epoxide

Epoxy Technology Inc.

Message:

A two component, black colored and optically opaque epoxy designed for optical, medical, and opto-electronic packaging of semiconductor devices and components. It is a modification of EPO-TEK ® 320 for increased electrical insulation. It is also more viscous and thixotropic. Can be used for adhesion, sealing, potting and encapsulation.

General Information			
Features	Thixotropic		
Uses	Adhesives		
	Electrical/Electronic Applications		
	Medical/Healthcare Applications		
	Optical Applications		
	Seals		
Agency Ratings	EC 1907/2006 (REACH)		
	EU 2003/11/EC		
	EU 2006/122/EC		
RoHS Compliance	RoHS Compliant		
Forms	Paste		
Processing Method	Encapsulating		
	Potting		
Physical	Nominal Value	Unit	
	Nominal Value < 20.0	Unit µm	
Particle Size			
Particle Size Degradation Temperature	< 20.0	μm	
Particle Size Degradation Temperature Die Shear Strength - >10 kg (23°C)	< 20.0 340	μm °C	
Particle Size Degradation Temperature Die Shear Strength - >10 kg (23°C)	< 20.0 340	μm °C	
Particle Size Degradation Temperature Die Shear Strength - >10 kg (23°C) Operating Temperature	< 20.0 340 23.4	μm °C MPa	
Particle Size Degradation Temperature Die Shear Strength - >10 kg (23°C) Operating Temperature Continuous Intermittent	< 20.0 340 23.4 -55 to 175	μm °C MPa	
Particle Size Degradation Temperature Die Shear Strength - >10 kg (23°C) Operating Temperature Continuous Intermittent Storage Modulus (23°C)	< 20.0 340 23.4 -55 to 175 -55 to 275	μm °C MPa °C °C	
Particle Size Degradation Temperature Die Shear Strength - >10 kg (23°C) Operating Temperature Continuous Intermittent Storage Modulus (23°C) Thixotropic Index	< 20.0 340 23.4 -55 to 175 -55 to 275 4.72	μm °C MPa °C °C	
Particle Size Degradation Temperature Die Shear Strength - >10 kg (23°C) Operating Temperature Continuous Intermittent Storage Modulus (23°C) Thixotropic Index	< 20.0 340 23.4 -55 to 175 -55 to 275 4.72	μm °C MPa °C °C	
Particle Size Degradation Temperature Die Shear Strength - >10 kg (23°C) Operating Temperature Continuous Intermittent Storage Modulus (23°C) Thixotropic Index Weight Loss on Heating	< 20.0 340 23.4 -55 to 175 -55 to 275 4.72 3.20	μm °C MPa °C °C GPa	
Intermittent Storage Modulus (23°C) Thixotropic Index Weight Loss on Heating 200°C	< 20.0 340 23.4 -55 to 175 -55 to 275 4.72 3.20 0.17	μm °C MPa °C °C GPa	
Particle Size Degradation Temperature Die Shear Strength - >10 kg (23°C) Operating Temperature Continuous Intermittent Storage Modulus (23°C) Thixotropic Index Weight Loss on Heating 200°C 250°C	< 20.0 340 23.4 -55 to 175 -55 to 275 4.72 3.20 0.17 0.35	μm °C MPa °C °C GPa %	

2	2.0E-5	cm/cm/°C
³	8.2E-5	cm/cm/°C
Optical	Nominal Value	Unit
Transmittance (300 to 2500 nm)	< 1.0	%
Thermoset	Nominal Value	Unit
Thermoset Components		
Part A	Mix Ratio by Weight: 10	
Part B	Mix Ratio by Weight: 1.0	
Shelf Life (23°C)	52	wk
Uncured Properties	Nominal Value	Unit
Color		
⁴	Black	
⁵	Clear/Transparent	
Density		
Part B	0.868	g/cm³
Part A	2.42	g/cm³
Viscosity ⁶ (23°C)	1.5 to 3.0	Pa·s
Curing Time (70°C)	1.0	hr
Pot Life	30	min
Cured Properties	Nominal Value	Unit
Shore Hardness (Shore D)	89	
Lap Shear Strength (23°C)	10.9	MPa
Relative Permittivity (1 kHz)	9.75	
Volume Resistivity (23°C)	> 1.0E+13	ohms·cm
Dissipation Factor (1 kHz)	0.033	
NOTE		
1.	Dynamic Cure 20-200°C/ISO 25 Min; Ramp -10-200°C @ 20°C/Min	
2.	Below Tg	
3.	Above Tg	
4.	Part A	
5.	Part B	
6.	100 rpm	

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